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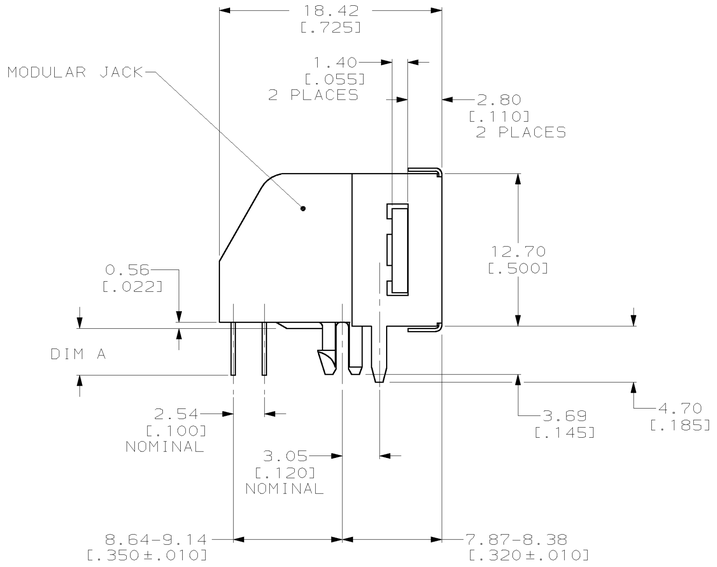
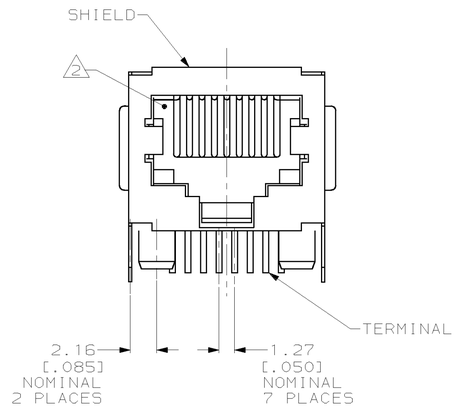
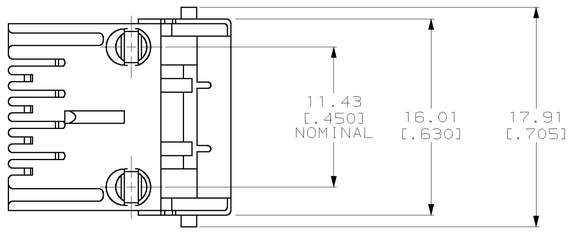
LOC	DIST
AA	22

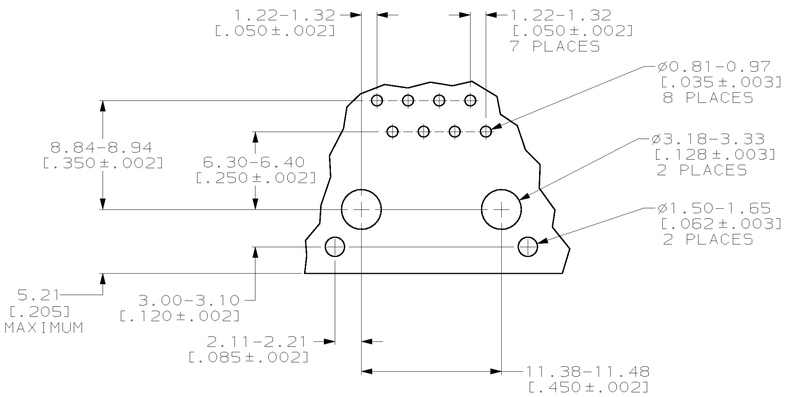
REVISIONS

P	LTR	DESCRIPTION	DATE	DWN	APVD
	J	REVISED; EC 0UF0-0102-01	17AUG01	DLD	LLV

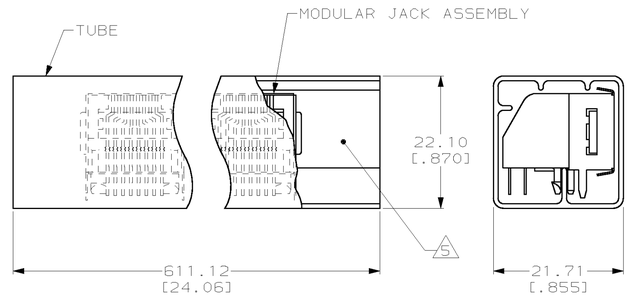








SUGGESTED PRINTED CIRCUIT BOARD
MOUNTING HOLE LAYOUT
(VIEW SHOWN IS CIRCUIT SIDE OF BOARD)



DETAIL B
SCALE 2:1

1. MATERIAL:
HOUSING - PBT POLYESTER BLACK.
TERMINAL - 0.36[.014] THICK PHOS-BRONZE PLATED WITH 1.27µm[.000050] THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 2.03µm[.000080] THICK TIN-LEAD IN SOLDER AREA OVER 1.27µm[.000050] THICK NICKEL UNDERPLATE.
SHIELD - 0.25[.010] THICK COPPER ALLOY, TIN-LEAD PLATED.

2. CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68, SUBPART F.

3. DIMENSIONS ARE MAXIMUM UNLESS OTHERWISE SPECIFIED.

4. BULK PACKAGED IN A TRAY.

5. 32 ASSEMBLIES PACKAGED PER TUBE, SEE DETAIL B.

DIM A	PACKAGED	PART NUMBER
1.78-2.79[.09±.02]	4	555153-6
2.54-3.05[.11±.01]	4	555153-5
4.06-4.57[.17±.01]	5	555153-4
3.30-4.32[.15±.02]	5	555153-3
3.30-4.32[.15±.02]	4	555153-1

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: mm [INCHES]

TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ±-, 1 PLC ±-, 2 PLC ±-, 3 PLC ±-, 4 PLC ±-, ANGLES ±-

MATERIAL: 1

FINISH: 1

DWN J. GALUCCI/UTA 20MAY94
CHK D. HUSSEY 24MAY94
APVD J. TONEY 25MAY94

AMP Incorporated
Harrisburg, PA 17105-3608

NAME: MODULAR JACK ASSEMBLY, 8 POSITION, SHIELDED, LOW PROFILE, RIGHT ANGLE WITH PRINTED CIRCUIT BOARD GROUND AND PANEL STOPS

PRODUCT SPEC: -
APPLICATION SPEC: -
WEIGHT: -

SIZE	CAGE CODE	DRAWING NO	RESTRICTED TO
A1	00779	C-555153	-

CUSTOMER DRAWING

SCALE	SHEET	REV
4:1	1 OF 1	J